Click here to ask an associate for production status of specific part numbers.

MAX20010C/MAX20010D/ MAX20010E

Automotive Single 6A Step-Down Converters

General Description

The MAX20010C/MAX20010D/MAX20010E ICs are high-efficiency, synchronous step-down converters that operate with a 3.0V to 5.5V input voltage range and provide a 0.5V to 1.5875V output voltage range. The wide input/output voltage range and the ability to provide up to 6A load current make these ICs ideal for on-board point-of-load and post-regulation applications. The ICs achieve ±2% output error over load, line, and temperature ranges. The MAX20010D/MAX20010E offers improved transient response.

The ICs feature a 2.2MHz fixed-frequency PWM mode for better noise immunity and load-transient response, and a pulse-frequency modulation mode (skip) for increased efficiency during light-load operation. The 2.2MHz frequency operation allows the use of all-ceramic capacitors and minimizes the solution footprint. The programmable spread-spectrum frequency modulation minimizes radiated electromagnetic emissions. Integrated low RDS(ON) switches improve efficiency at heavy loads and make the layout a much simpler task with respect to discrete solutions.

The ICs are offered with factory-preset output voltages (see the <u>Ordering Information</u> for options). The I²C interface supports dynamic voltage adjustment with programmable slew rates. Other features include programmable soft-start, overcurrent, and overtemperature protections.

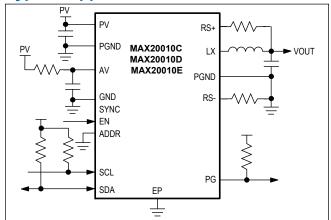
Applications

Automotive

Benefits and Features

- Fully Integrated, Synchronous 6A DC-DC Converter Enables Small Solution Size
 - 3.0V to 5.5V Operating Supply Voltage
- High-Precision Voltage Regulator for Applications Processors
 - ±2% Output-Voltage Accuracy
 - · Differential Remote Voltage Sensing
 - I²C-Controlled Output Voltage of 0.5V to 1.27V in 10mV Steps, or 0.625V to 1.5875V in 12.5mV Steps
 - · Excellent Load-Transient Performance
- Low-Noise Feature Reduces EMI
 - 2.2MHz Operation
 - · Spread-Spectrum Option
 - · Frequency-Synchronization Input/Output
 - · Current-Mode, Forced-PWM, and Skip Operation
- Robust for the Automotive Environment
 - PGOOD Output
 - · Overtemperature and Short-Circuit Protection
 - 20-Pin (4mm x 4mm) TQFN with an Exposed Pad
 - -40°C to +125°C Operating Temperature Range
 - AECQ-100 Qualified

Typical Application Circuits



Automotive Single 6A Step-Down Converters

Absolute Maximum Ratings

PV, AV to GND	0.3V to +6V
ADDR, EN, PG, RS+, RS-, SYN	IC to GND0.3V to V_{AV} + 0.3V
SDA, SCL to GND	0.3V to +6V
GND to PGND	0.3V to +0.3V
LX to PGND (<i>Note 1</i>)	0.3V to V _{PV} + 0.3V
Output Short-Circuit Duration	Continuous

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
TQFN (derate 30.3mW/°C above +70°C)	2424.2mW
Operating Temperature Range	40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	

Note 1: Self-protected against transient voltages exceeding these limits for ≤ 50ns under normal operation and loads up to the maximum rating output current.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

20 TQFN-EP

Package Code	T2044+4C
Outline Number	21-100172
Land Pattern Number	90-0409

20 SW TQFN-EP

Package Code	T2044Y+4C
Outline Number	<u>21-100068</u>
Land Pattern Number	90-0409
THERMAL RESISTANCE, FOUR-LAYER BOARD	
Junction to Ambient (θ _{JA})	33°C/W
Junction to Case (θ_{JC})	2°C/W

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{PV} = V_{AV} = 5.0V. T_A = T_J = -40^{\circ}C$ to +125°C, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$ under normal conditions, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	С	MIN	TYP	MAX	UNITS	
Supply Voltage Range	V _{IN}	Fully operationa	Fully operational			5.5	V
Lindonyoltaga Laakaut	UVLO	Rising		2.85	3	V	
Undervoltage Lockout	UVLO	Falling		2.55		V	
Shutdown Supply		EN = low	T _A = +25°C		2.5	5	
Current	i i i i i i i i i i i i i i i i i i i		EN = low $T_A = +125^{\circ}C$		4.5		μA
Supply Current	I _{IN}	EN = high, I _{OU1} skip mode	_r = 0mA,		300		μA

Electrical Characteristics (continued)

 $(V_{PV} = V_{AV} = 5.0V. T_A = T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$ under normal conditions, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
PWM Switching Frequency	fsw	Internally generated		2.0	2.2	2.4	MHz	
Spread Spectrum		CONFIG.SS = 1			+3		%	
Voltage Acquirect		$I_{LOAD} = 0A \text{ to } 6A,$ $3.0V \le V_{PV} \le 5.5V$	0.80V to 1.5875V	-2		+2	%	
Voltage Accuracy	V _{OUT}	$I_{LOAD} = 0A \text{ to } 6A,$ $3.0V \le V_{PV} \le 5.5V$	0.50V to 0.79V	-16		+21	mV	
pMOS On-Resistance		V _{PV} = V _{AV} = 5V, I _L	X = 1A		31	55	mΩ	
nMOS On-Resistance		V _{PV} = V _{AV} = 5V, I _L	X = 1A		18	31	mΩ	
pMOS Current-Limit Threshold				7.76	9.70	11.64	А	
nMOS Zero Crossing Threshold					60		mA	
		$V_{PV} = V_{AV}$	T _A = +25°C		0.5	5		
LX Leakage Current		= 6V, LX = PGND or PV	T _A = +125°C		4		μA	
Duty-Cycle Range		PWM mode				100	%	
Minimum On-Time					36	75	ns	
THERMAL OVERLOAD								
Thermal-Shutdown Temperature		T _J rising			165		°C	
Hysteresis					15		°C	
POWER-GOOD OUTPUT	(PG)							
PG Overvoltage (OV)		Percentage of nominal output,	0.5V < V _{OUT} < 0.79V	104	108	112		
Threshold, Rising		output voltage rising, blanked during slewing	0.8V < V _{OUT} < 1.5875V	105	108	111	%	
DO 11 a de 2021/2022 (10.0)		Percentage of nominal output,	0.5V < V _{OUT} < 0.79V	88	92	96		
PG Undervoltage (UV) Threshold, Falling		output voltage falling, blanked during slewing	0.8V < V _{OUT} < 1.5875V	89	92	95	%	
Active Timeout Period					256		Clocks	
UV/OV Propagation Delay					5		μs	
PG Output High- Leakage Current						1	μA	
PG Output Low Level		$3.0V \le V_{PV} \le 5.5V$, $\le 5.5V$, sinking -2m				0.2	V	
DIGITAL INPUTS (SYNC	, EN, ADDR)							
Input High Level	V _{IH}			1.5			V	
Input Low Level	V _{IL}					0.5	V	

Electrical Characteristics (continued)

 $(V_{PV} = V_{AV} = 5.0V. T_A = T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$ under normal conditions, unless otherwise noted.) (Note 2)

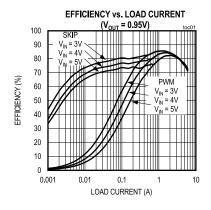
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Hysteresis				0.1		V
EN Input Leakage Current		0V ≤ V _{PV} ≤ 5.5V, 0V ≤ V _{AV} ≤ 5.5V		0.1		μΑ
Enable Time		Rising EN to beginning of soft-start		140		μs
SYNC Input Pulldown				100	150	kΩ
SYNC Input Frequency Range			1.8		2.6	MHz
SYNC OUTPUT	•					
Output Low	V _{OL}	I _{SINK} = 3mA			0.4	V
Output High	V _{OH}	$V_{PV} = V_{AV} = 5.0V$, $I_{SOURCE} = 3mA$	4.2			V
DIGITAL INPUTS (SDA,	SCL)					
Input High Level	V _{IH_I2C}		1.3			V
Input Low Level	V _{IL_I2C}				0.5	V
Input Hysteresis				0.1		V
Input Leakage Current		0V ≤ V _{PV} ≤ 5.5V, 0V ≤ V _{AV} ≤ 5.5V		0.1		μA
I ² C INTERFACE	1		<u>'</u>			'
Clock Frequency	f _{SCL}				3.4	MHz
Setup Time (Repeated) START	tsu:STA	(<u>Note 3</u>)	160			ns
Hold Time (Repeated) START	t _{HD:STA}	(<u>Note 3</u>)	160			ns
SCL Low Time	t _{LOW}	(<u>Note 3</u>)	160			ns
SCL High Time	tHIGH	(<u>Note 3</u>)	60			ns
Data Setup Time	t _{SU:DAT}	(<u>Note 3</u>)	50			ns
Data Hold Time	t _{HD:DAT}	(<u>Note 3</u>)	0		70	ns
Setup Time for STOP Condition	t _{SU:STO}	(<u>Note 3</u>)	160			ns
Spike Suppression		(<u>Note 3</u>)		20		ns
SDA Output Low	V _{OL_SDA}	I _{SINK} = 13mA			0.4	V

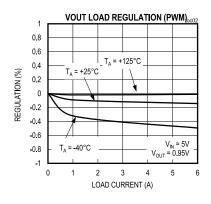
Note 2: All units are 100% production tested at $T_A = +25$ °C. All temperature limits are guaranteed by design.

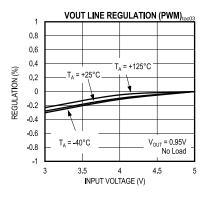
Note 3: Guaranteed by design. Not production tested.

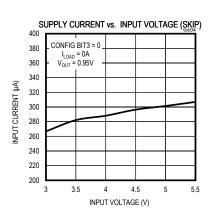
Typical Operating Characteristics

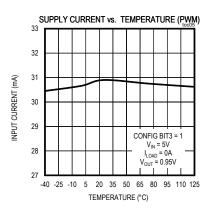
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

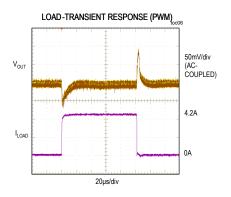


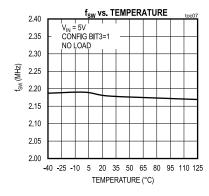


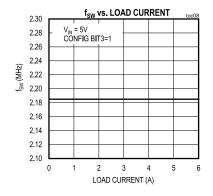


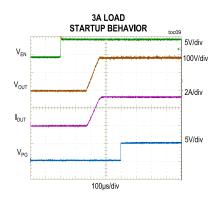






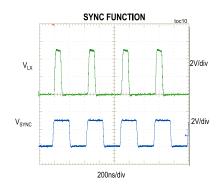


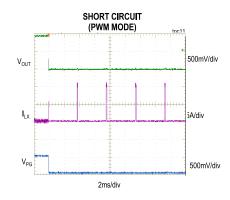


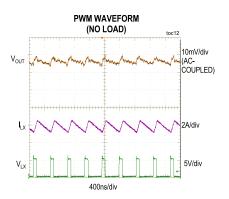


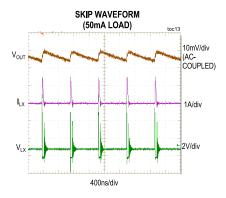
Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

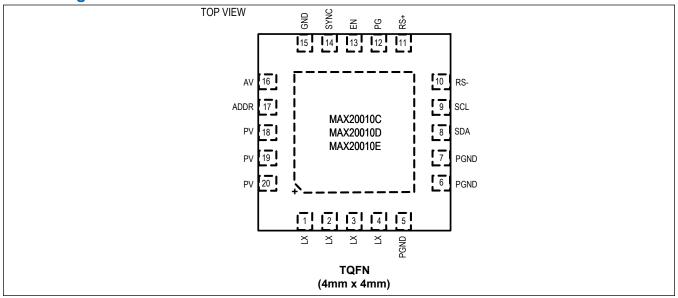








Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1–4	LX	Inductor Connection. Connect LX to the switched side of the inductor. Connect all LX pins together.
5–7	PGND	Power Ground. Connect all PGND pins together.
8	SDA	I ² C Data I/O
9	SCL	I ² C Clock Input
10	RS-	Buck Regulator Remote Voltage-Sense Negative Input
11	RS+	Buck Regulator Remote Voltage-Sense Positive Input
12	PG	Open-Drain Power-Good Output. This output remains low for 120µs after the output has reached its regulation level (see the <i>Electrical Characteristics</i> table). To obtain a logic signal, pull up PG with an external resistor.
13	EN	Active-High Enable Input. When EN is high, the device enters soft-start. When EN is low, the device enters soft-shutdown.
14	SYNC	SYNC I/O. When configured as an input, connect SYNC to GND or leave unconnected to enable skipmode operation under light loads. Connect SYNC to AV or an external clock to enable fixed-frequency, forced-PWM (FPWM) mode operation. When configured as an output, connect SYNC to other devices' SYNC inputs.
15	GND	Analog Ground
16	AV	Analog Input Supply. Filter AV using a 100Ω resistor from PV and a $1\mu F$ ceramic capacitor from AV to GND.
17	ADDR	I ² C Address Select. See the <u>Ordering Information</u> table for default I ² C settings.
18–20	PV	Power Input Supply. Connect a 4.7μF or larger ceramic capacitor from PV to PGND. Connect all PV pins together.
-	EP	Exposed Pad. Connect EP to ground. Connecting the exposed pad to ground does not remove the requirement for proper ground connections to PGND. The exposed pad is attached with epoxy to the substrate of the die, making it an excellent path to remove heat from the IC.

Automotive Single 6A Step-Down Converters

Detailed Description

The MAX20010C/MAX20010D/MAX20010E ICs are high-efficiency, synchronous step-down converters that operate with a 3.0V to 5.5V input voltage range and provide a 0.5V to 1.5875V output voltage range. The ICs deliver up to 6A of load current and achieve ±2% output error over load, line, and temperature ranges. The MAX20010D/MAX20010E offers improved transient performance.

Optional spread-spectrum frequency modulation minimizes radiated electromagnetic emissions due to the switching frequency. The I²C-programmable I/O (SYNC) enables system synchronization.

Integrated low $R_{DS(ON)}$ switches help improve efficiency at heavy loads and make the layout a much simpler task with respect to discrete solutions. The ICs are offered with a factory-preset output voltage that is dynamically adjustable through the I²C interface. The output voltage can be set to any desired value between 0.5V and 1.27V in 10mV steps, and between 0.625V and 1.5875V in 12.5mV steps.

Additional features include adjustable soft-start, power-good delay, DVS rate, overcurrent, and overtemperature protections (see Figure 1).

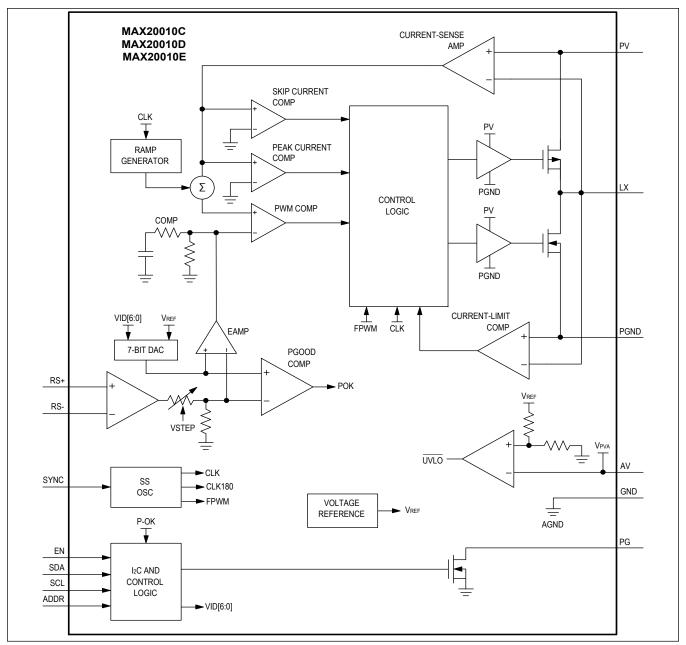


Figure 1. Internal Block Diagram

I²C Interface

The ICs feature an I²C, 2-wire serial interface consisting of a serial-data line (SDA) and serial-clock line (SCL). SDA and SCL facilitate communication between the ICs and the master at clock rates up to 3.4MHz. The master, typically a microcontroller, generates SCL and initiates data transfer on the bus. Figure 2 shows the 2-wire interface timing diagram. A master device communicates with the ICs by transmitting the proper address followed by the data word. Each transmit sequence is framed by a START (S) or Repeated START (Sr) condition and a STOP (P) condition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge clock pulse.

The SDA line operates as both an input and an open-drain output. A pullup resistor greater than 500Ω is required on the

SDA bus. The SCL line operates as an input only. A pullup resistor greater than 500Ω is required on SCL if there are multiple masters on the bus, or if the master in a single-master system has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. The SCL and SDA inputs suppress noise spikes to assure proper device operation even on a noisy bus.

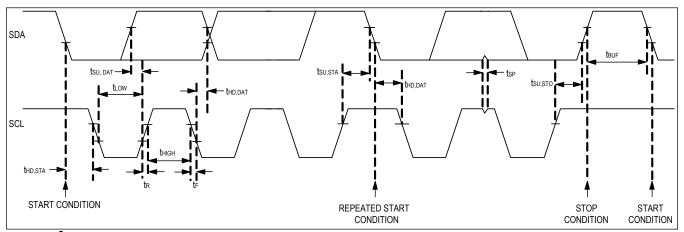


Figure 2. I²C Timing Diagram

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the <u>START and STOP Conditions</u> section). SDA and SCL idle high when the I2C bus is not busy.

START and STOP Conditions

A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 3).

A START (S) condition from the master signals the beginning of a transmission to the IC. The master terminates transmission, and frees the bus, by issuing a STOP (P) condition. The bus remains active if a Repeated START (Sr) condition is generated instead of a STOP condition.

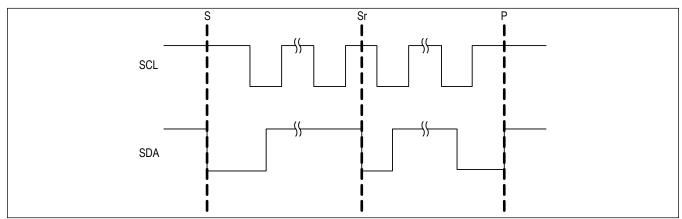


Figure 3. START, STOP, and Repeated START Conditions

Early STOP Condition

The ICs recognize a STOP condition at any point during data transmission, except if the STOP condition occurs in the

same high pulse as a START condition.

Clock Stretching

In general, the clock-signal generation for the I^2C bus is the responsibility of the master device. The I^2C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The ICs do not use any form of clock stretching to hold down the clock line.

I²C General Call Address

The ICs do not implement the I^2C specification's "general call address." If the IC sees the general call address (0b0000_0000), it does not issue an acknowledge.

Slave Address

Once the device is enabled, the I²C slave address is defined as the 7 most significant bits (MSBs) followed by the R/W bit which completes the 8-bit I²C transaction. Set the R/W bit to 0 to configure the IC to write mode. Set the R/W bit to 1 to configure the IC to read mode. The address is the first byte of information sent to the device after the START condition. The ADDR pin (A0) can be used to change the default I²C slave address. See <u>Table 1</u> for the 7-bit I²C slave addresses and the 8-bit Write/Read addresses.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the ICs use to handshake receipt each byte of data (Figure 4). The device pulls down SDA during the master-generated 9th clock pulse. The SDA line must remain stable and low during the high period of the acknowledge clock pulse. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master can reattempt communication.

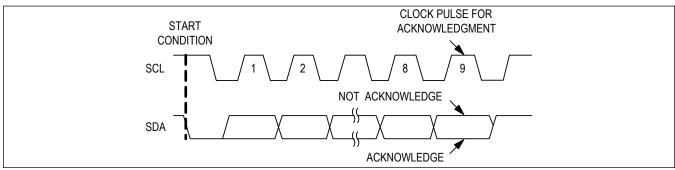


Figure 4. Acknowledge Condition

Table 1. I²C Slave Addresses

A6	A5	A4	A3	A2*	A1*	A0	I ² C ADDR	WRITE	READ
0	1	1	1	0	0	0	0x38	0x70	0x71
0	1	1	1	0	0	1	0x39	0x72	0x73
0	1	1	1	0	1	0	0x3A	0x74	0x75
0	1	1	1	0	1	1	0x3B	0x76	0x77
0	1	1	1	1	0	0	0x3C	0x78	0x79
0	1	1	1	1	0	1	0x3D	0x7A	0x7B
0	1	1	1	1	1	0	0x3E	0x7C	0x7D
0	1	1	1	1	1	1	0x3F	0x7E	0x7F

^{*}See the Ordering Information table for the 7-bit default settings for ADDR=0.

Automotive Single 6A Step-Down Converters

Write Data Format

A write to the device includes:

- Transmission of a START condition
- Slave address with the write bit set to 0
- 1 byte of data to the register address
- 1 byte of data to the command register
- STOP condition

(Figure 5 illustrates the proper format for one frame)

Read Data Format

A read from the device includes:

- Transmission of a START condition
- Slave address with the write bit set to 0
- 1 byte of data to the register address
- · Restart condition
- Slave address with the read bit set to 1
- 1 byte of data to the command register
- STOP condition

(Figure 5 illustrates the proper format for one frame)

Writing to a Single Register

<u>Figure 6</u> shows the protocol for the I²C master device to write 1 byte of data to the ICs. This protocol is the same as the SMBus specification's "write byte" protocol.

The "write byte" protocol is as follows:

- 1. Master sends a START command (S).
- 2. Master sends the 7-bit slave address followed by awrite bit (R/W = 0).
- 3. Addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4. Master sends an 8-bit register pointer.
- 5. Slave acknowledges the register pointer.
- 6. Master sends a data byte.
- 7. Slave updates with the new data.
- 8. Slave acknowledges or not acknowledges the databyte. The next rising edge on SDA loads the data byteinto its target register and the data becomes active.
- 9. Master sends a STOP condition (P) or a RepeatedSTART condition (Sr).

Writing Multiple Bytes Using Register-Data Pairs

<u>Figure 7</u> shows the protocol for the I²C master device to write multiple bytes to the ICs using register-data pairs. This protocol allows the I²C master device to address the slave only once and then send data to multiple registers in a random order. Registers can be written continuously until the master issues a STOP condition.

The "multiple byte register-data pair" protocol is as follows:

- 1. Master sends a START command.
- 2. Master sends the 7-bit slave address followed by a write bit.
- 3. Addressed slave asserts an acknowledge by pulling SDA low.
- 4. Master sends an 8-bit register pointer.
- 5. Save acknowledges the register pointer.
- 6. Master sends a data byte.
- 7. Slave acknowledges the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
- 8. Steps 4–7 are repeated as many times as the master requires.
- 9. Master sends a STOP condition. During the rising edge of the stop-related SDA edge, the data byte that was

previously written is loaded into the target register and becomes active.

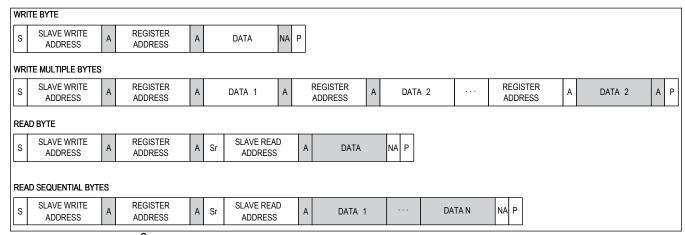


Figure 5. Data Format of I²C Interface

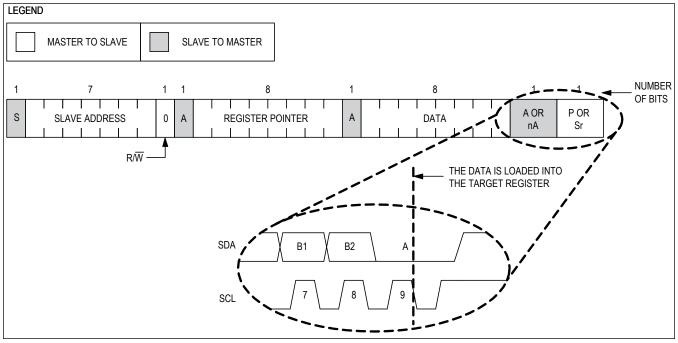


Figure 6. Write Byte Format

PG Output

The ICs feature an open-drain PGOOD output that asserts low when the output voltage exceeds the PG_OV and PG_UV thresholds. PG remains low for a fixed timeout period after the output is within the regulation window. Connect PG to a logic supply using a pullup resistor.

Soft-Start

The ICs include a programmable startup fixed soft-start rate. Soft-start time limits startup inrush current by forcing the output voltage to ramp up towards its regulation point.

Automotive Single 6A Step-Down Converters

Enable (EN)

EN high triggers soft-start and EN low starts soft-shutdown sequence. When EN is used to shut down the buck output, it should stay low for a minimum of 1ms for the soft-shutdown sequence to complete in order to guarantee that the PG pin deassertion does not occur immediately when EN goes high. If the PG pin is unused or early deassertion of the PG pin does not cause a system issue, then there is no restriction on the EN pin timing.

Shutdown

During shutdown, the output voltage is ramped down at the 5.5mV/µs slew rate. Once the controlled ramp is stopped, the output voltage is typically around 0.15V at no load. If the IC is re-enabled before shutdown is complete, PG will deassert immediately and not wait for the output to be in the regulation window.

Spread-Spectrum Option

The ICs, featuring spread-spectrum (SS) operation, vary the internal operating frequency down by 3% relative to the internally generated operating frequency of 2.2MHz (typ). This function does not apply to externally applied oscillation frequency.

Synchronization (SYNC)

SYNC is factory-programmable I/O (see <u>Ordering Information</u> for the available options). When SYNC is configured as an input, a logic-high on the FPWM bit enables SYNC to accept signal frequencies in the range of $1.8 \text{MHz} < f_{\text{SYNC}} < 2.6 \text{MHz}$. When SYNC is configured as an output, it outputs the internal PWM switching frequency.

Current-Limit/Short-Circuit Protection

The current-limit feature protects the ICs against short-circuit and overload conditions at the output. After soft-start is completed, if V_{OUT} is less than 50% of the set value and the IC is in current limit, the IC shuts off for 4ms (at 2.2MHz switching frequency) and repeats soft-start. This cycle repeats until the short or overload condition is removed. See the short-circuit (PWM) waveform for an example.

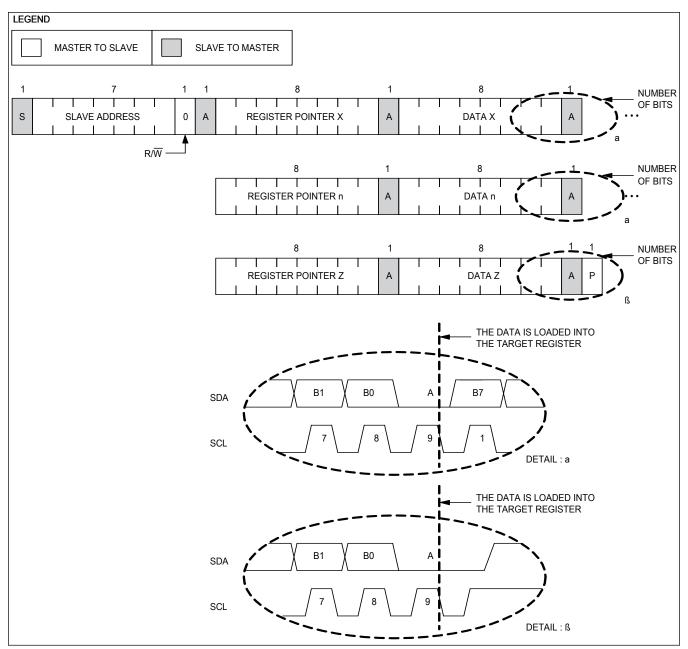


Figure 7. Write Register (Data-Pair Format)

Table 2. Register Map

	•										
REG	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	REGISTER ADDRESS	R/W	POWER- ON RESET
ID	DEV3	DEV2	DEV1	DEV0	R3	R2	R1	R0	0x00	R	0x00
_	_	_	_	_	_	_	_	_	0x01	R/W	0x00
VIDMAX	_	VMAX6	VMAX5	VMAX4	VMAX3	VMAX2	VMAX1	VMAX0	0x02	R/W	OTP

Table 2. Register Map (continued)

Reserved*	Reserved*	_	_	_	_	_	Reserved*	Reserved*	0x03	R/W	0x02
STATUS	INTERR	Reserved*	VRHOT	UV	OV	ОС	VMERR	0	0x04	R	0x00
CONFIG	VSTEP	_	_	_	FPWM	SS	SO1	SO0	0x05	R/W	OTP
SLEW	_	_	_	_	SR3	SR2	SR1	SR0	0x06	R/W	OTP
VID	_	VID6	VID5	VID4	VID3	VID2	VID1	VID0	0x07	R/W	OTP
Reserved*	_	_	Reserved*	Reserved*	Reserved*	Reserved*	Reserved*	Reserved*	0x2B	R/W	0x00

^{*}Note: Reserved registers and bits are not used for readback; they are reserved for internal use.

Table 3. Identification Registers (ID)

	ID									
BIT NO.	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0		
NAME	DEV3	DEV2	DEV1	DEV0	R3	R2	R1	R0		
POR	0	0	0	0	0	0	0	0		

BIT	BIT DESCRIPTION
DEV[7:4]	Device ID: MAX20010C/MAX20010D/MAX20010E = 0x0
R[3:0]	0x3

Table 4. Maximum Voltage-Setting Registers (VIDMAX)

	VIDMAX												
BIT NO.	7	6	5	4	3	2	1	0					
NAME	_	VMAX6	VMAX5	VMAX4	VMAX3	VMAX2	VMAX1	VMAX0					
POR	OTP	OTP	OTP	OTP	OTP	OTP	OTP	OTP					

BIT	BIT DESCRIPTION
	Maximum Voltage Setting:
VMAX[6:0]	If VID[] > VMAX[], a fault is set and the actual voltage will be capped by VMAX[]. See <u>Table 9</u> for voltage selections.

Table 5. Configuration Registers (CONFIG)

	CONFIG											
BIT NO.	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0				
NAME	VSTEP	_	_	_	FPWM	SS	SO1	SO0				
POR	OTP	OTP	OTP	OTP	OTP	OTP	OTP	OTP				

BIT	BIT DESCRIPTION
VSTEP	Voltage Step Size—Sets the voltage step size for the LSB of SETVOUT: 0 = 10mV 1 = 12.5mV
FPWM	Forced-PWM Mode: 0 = Mode controlled by SYNC pin. When SYNC is output device is always FPWM mode. 1 = Forced-PWM Mode. Overrides SYNC skip mode setting when SYNC is an input.
SS	Spread-Spectrum Clock Setting: 0 = Disabled 1 = +3% spread
SO[1:0]	SYNC I/O Select: 00 = Master: Input, rising edge starts cycle 01 = Master: Input, falling edge starts cycle 10 = Master: Output, falling edge starts cycle 11 = Unused

Table 6. Status Registers (STATUS)

	STATUS												
BIT NO.	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0					
NAME	INTERR	Reserved*	VRHOT	UV	OV	ОС	VMERR	0					
POR	0	0	0	0	0	0	0	0					

BIT	BIT DESCRIPTION
INTERR	Internal Hardware Error: This bit is set to 1 when ATE trimming and testing is not complete.
Reserved	Reserved registers and bits are not used for readback; they are reserved for internal use.
VRHOT	Thermal-Shutdown Indication: This bit indicates if thermal shutdown has occurred since the last time the STATUS register was read.
UV	VOUT Undervoltage: This bit indicates if the output is currently under the target voltage.
OV	VOUT Overvoltage: This bit indicates if the output is currently over the target voltage.
ОС	VOUT Overcurrent: This bit indicates if an overcurrent event has occurred since the last time the STATUS register was read.
VMERR	VOUT MAX Error: Set to 1 if VID[] > VOUTMAX[] is in normal mode.

Table 7. Slew-Rate Registers (SLEW)

	SLEW											
BIT NO.	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0				
NAME	_	_	_	_	SR3	SR2	SR1	SR0				
POR	OTP											

SR[3:0]	SOFT-START SLEW RATE (mV/µs)*	DVS SLEW RATE (mV/µs)*
XXXX0000	22	22
XXXX0001	11	22
XXXX0010	5.5	22
XXXX0011	11	11
XXXX0100	5.5	11
XXXX0101	44	44
XXXX0110	22	44
XXXX0111	11	44
XXXX1000	5.5	44
XXXX1001	5.5	5.5
XXXX1010—XXXX1111	Reserved	Reserved

^{*}Note: VSTEP = '0'; when VSTEP = '1', increase by a factor of 1.25.

Table 8. Output-Voltage Registers, VID

				VID						
BIT NO.	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0		
NAME	_	VID6	VID5	VID4	VID3	VID2	VID1	VID0		
POR	OTP									
DIT DESCRIPTION										

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VID[6:0]

Target Voltage Setting:

VOUT ramps at the programmed DVS ramp until it reaches VSET. See <u>Table 9</u> for voltage selections.

Table 9. VID Output-Voltage Selections

VID[6:0]	VOUT (V) (VSTEP = 0)	VOUT (V) (VSTEP = 1)	VID[6:0]	VOUT (V) (VSTEP = 0)	VOUT (V) (VSTEP = 1)	VID[6:0]	VOUT (V) (VSTEP = 0)	VOUT (V) (VSTEP = 1)
0x00	OFF	OFF	0x20	0.810	1.0125	0x40	1.130	1.4125
0x01	0.500	0.6250	0x21	0.820	1.0250	0x41	1.140	1.4250
0x02	0.510	0.6375	0x22	0.830	1.0375	0x42	1.150	1.4375
0x03	0.520	0.6500	0x23	0.840	1.0500	0x43	1.160	1.4500
0x04	0.530	0.6625	0x24	0.850	1.0625	0x44	1.170	1.4625
0x05	0.540	0.6750	0x25	0.860	1.0750	0x45	1.180	1.4750
0x06	0.550	0.6875	0x26	0.870	1.0875	0x46	1.190	1.4875
0x07	0.560	0.7000	0x27	0.880	1.1000	0x47	1.200	1.5000
80x0	0.570	0.7125	0x28	0.890	1.1125	0x48	1.210	1.5125
0x09	0.580	0.7250	0x29	0.900	1.1250	0x49	1.220	1.5250
0x0A	0.590	0.7375	0x2A	0.910	1.1375	0x4A	1.230	1.5375
0x0B	0.600	0.7500	0x2B	0.920	1.1500	0x4B	1.240	1.5500
0x0C	0.610	0.7625	0x2C	0.930	1.1625	0x4C	1.250	1.5625
0x0D	0.620	0.7750	0x2D	0.940	1.1750	0x4D	1.260	1.5750
0x0E	0.630	0.7875	0x2E	0.950	1.1875	0x4E	1.270	1.5875
0x0F	0.640	0.8000	0x2F	0.960	1.2000			
0x10	0.650	0.8125	0x30	0.970	1.2125			
0x11	0.660	0.8250	0x31	0.980	1.2250			
0x12	0.670	0.8375	0x32	0.990	1.2375			
0x13	0.680	0.8500	0x33	1.000	1.2500			
0x14	0.690	0.8625	0x34	1.010	1.2625			
0x15	0.700	0.8750	0x35	1.020	1.2750			
0x16	0.710	0.8875	0x36	1.030	1.2875			
0x17	0.720	0.9000	0x37	1.040	1.3000			
0x18	0.730	0.9125	0x38	1.050	1.3125			
0x19	0.740	0.9250	0x39	1.060	1.3250			
0x1A	0.750	0.9375	0x3A	1.070	1.3375			
0x1B	0.760	0.9500	0x3B	1.080	1.3500			
0x1C	0.770	0.9625	0x3C	1.090	1.3625			
0x1D	0.780	0.9750	0x3D	1.100	1.3750			
0x1E	0.790	0.9875	0x3E	1.110	1.3875			
0x1F	0.800	1.0000	0x3F	1.120	1.4000			

PWM/Skip Modes

The ICs feature a SYNC input that puts the converter either in skip mode or forced-PWM mode of operation. See the <u>Pin Description</u> table for mode details. In PWM mode, the converter switches at a constant frequency with variable on-time. In skip mode, the converter's switching frequency is load-dependent until the output load reaches a certain threshold. At higher load current, the switching frequency does not change and the operating mode is similar to the PWM mode. Skip mode helps improve efficiency in light-load applications by transferring more energy to the output during each on cycle, so the converter does not switch MOSFETs on and off as often as is the case in PWM mode. Consequently, the gate

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charge and switching losses are much lower in skip mode.

Overtemperature Protection

Thermal-overload protection limits the total power dissipation in the ICs. When the junction temperature exceeds 165°C (typ), an internal thermal sensor shuts down the internal bias regulator and the step-down controller, allowing the ICs to cool. The thermal sensor turns on the ICs again after the junction temperature cools by 15°C.

Applications Information

Input Capacitor

The input filter capacitor reduces peak currents drawn from the power source and reduces noise and voltage ripple on the input caused by the circuit's switching.

The input capacitor RMS current requirement (I_{RMS}) is defined by the following equation:

$$I_{\text{RMS}} = I_{\text{LOAD(MAX)}} \frac{\sqrt{V_{\text{OUT}}(V_{\text{PV}} - V_{\text{OUT}})}}{V_{\text{PV}}}$$

 I_{RMS} has a maximum value when the input voltage equals twice the output voltage (V_{PV} = $2V_{OUT}$), so $I_{RMS(MAX)}$ = $I_{LOAD(MAX)}/2$.

Choose an input capacitor that exhibits less than +10°C self-heating temperature rise at the RMS input current for optimal long-term reliability:

$$ESP_{IN} = \frac{\Delta V_{ESR}}{I_{OUT} + \frac{\Delta I_{L}}{2}}$$

where:

$$\Delta I_L = \frac{(V_{\text{PV}} - V_{\text{OUT}}) \times V_{\text{OUT}}}{V_{\text{PV}} \times f_{\text{SW}} \times L}$$

and:

$$C_{\mathsf{IN}} = \frac{I_{\mathsf{OUT}} \times D(1 - D)}{\Delta V_{\mathsf{O}} \times f_{\mathsf{SW}}}$$

and

$$D = \frac{V_{\text{OUT}}}{V_{\text{PV}}}$$

I_{OUT} is the maximum output current, D is the duty cycle.

Inductor Selection

The ICs are optimized to use a nominal 0.22µH inductor value. 0.15µH to 0.33µH inductors can also be used.

Inductors are rated for maximum saturation current. The maximum inductor current equals the maximum load current in addition to half the peak-to-peak ripple current:

$$I_{PEAK} = I_{LOAD(MAX)} + \frac{\Delta I_{INDUCTOR}}{2}$$

The actual peak-to-peak inductor ripple current is calculated in the previous ΔI_1 equation.

The saturation current should be > IPEAK, or at least in a range where the inductance does not degrade significantly.

Output Capacitor

The MAX20010C is stable with $2x47\mu F$ (typ) or more of X7R ceramic capacitance on the output, while the MAX20010D/MAX20010E is stable with $3x47\mu F$ (typ). Phase and gain margin must be measured with the worst-case-derated output capacitance to ensure stability. Larger capacitance values can be used to minimize V_{SAG} and V_{SOAR} during load transients.

Setting the Output Voltage Externally

An external resistive divider can be used to set the output voltage higher than the programmed VID voltage. This should only be done with MAX20010EATPA/V+. To set the output voltage, connect a resistive divider from the output (OUT) to RS+ to GND, as shown in Figure 8 V_{OUT} should not exceed 5V. Select RFB2 (RS+ to GND resistor) ≤ 50 k Ω . Calculate

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RFB (OUT to RS+ resistor) with the following equation:

$$R_{\mathsf{FB1}} = R_{\mathsf{FB2}}[(\frac{V_{\mathsf{OUT}}}{V_{\mathsf{RS}+}}) - 1]$$

where V_{RS+} = programmed VID voltage. Capacitor C_{FB1} can help improve the phase margin when using a resistive divider. Determine C_{FB1} from the following equation:

$$C_{\text{FB1}} = 1 / (2 \times \pi \times R_{\text{FB1}} \times 80k)$$

When setting the output voltage externally, scale the inductance according to the V_{OUT}/V_{RS+} ratio. MAX20010EATPA/V+ parts are programmed with double internal slope compensation to allow for smaller inductance values. Set the inductance using the following equation:

$$L = V_{OUT} / V_{RS+} \times 220 nH / 2$$

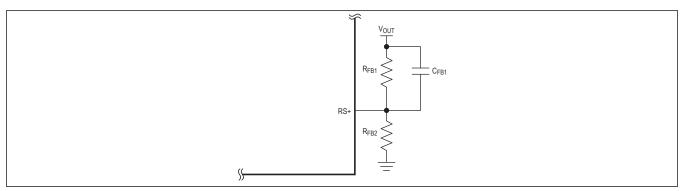


Figure 8. Adjustable Output-Voltage Setting

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Ordering Information

PART	PIN- PACKAGE	V _{OUT} (V)	VMAX[6:0]	CONFIG	VID[6:0]	SLEW	I ² C ADDR = 0
MAX20010CATPB/V+	20 TQFN-EP*	1.24	0x4B (1.24V)	0x08	0x4B (1.24V)	0x04	0x38
MAX20010CATPD/V+	20 TQFN-EP*	0.82	0x3C (1.09V)	0x0E	0x21 (0.82V)	0x09	0x38
MAX20010CATPE/V+	20 TQFN-EP*	0.80	0x29 (0.90V)	0x08	0x1F (0.80V)	0x09	0x3A
MAX20010CATPF/V+	20 TQFN-EP*	0.80	0x29 (0.90V)	0x08	0x1F (0.80V)	0x03	0x3A
MAX20010CATPJ/V+	20 TQFN-EP*	1.20	0x4C (1.25V)	0x08	0x47 (1.20V)	0x03	0x38
MAX20010CATPL/V+	20 TQFN-EP*	1.00	0x42 (1.15V)	0x06	0x33 (1.00V)	0x03	0x38
MAX20010CATPM/V+	20 TQFN-EP*	1.00	0x3D (1.10V)	0x08	0x33 (1.00V)	0x03	0x38
MAX20010CATPQ/V+	20 TQFN-EP*	0.60	0x1F (0.80V)	0x08	0x0B (0.60V)	0x03	0x38
MAX20010CATPT/V+**	20 TQFN-EP*	1.275	0x39 (1.325V)	0x8C	0x35 (1.275V)	0x03	0x38
MAX20010CATPU/V+	20 TQFN-EP*	1.03	0x3B (1.08V)	0x0C	0x36 (1.03V)	0x00	0x38
MAX20010CATPW/V+	20 TQFN-EP*	0.80	0x29 (0.90V)	0x04	0x1F (0.80V)	0x04	0x38
MAX20010CATPX/V+	20 TQFN-EP*	1.00	0x42 (1.15V)	0x04	0x33 (1.00V)	0x04	0x38
MAX20010CATPY/V+	20 TQFN-EP*	0.75	0x2E (0.95V)	0x00	0x1A (0.75V)	0x02	0x38
MAX20010DATPN/V+	20 TQFN-EP*	1.00	0x42 (1.15V)	0x08	0x33 (1.00V)	0x03	0x38
MAX20010DATPO/V+	20 TQFN-EP*	0.91	0x42 (1.15V)	0x08	0x2A (0.91V)	0x03	0x38
MAX20010DATPO/VY+	20 SW TQFN-EP*	0.91	0x42 (1.15V)	0x08	0x2A (0.91V)	0x03	0x38
MAX20010DATPP/V+	20 TQFN-EP*	0.87	0x42 (1.15V)	0x08	0x26 (0.87V)	0x03	0x38
MAX20010DATPQ/V+	20 TQFN-EP*	0.92	0x42 (1.15V)	0X08	0x2B (0.92V)	0x03	0x38
MAX20010DATPR/V+	20 TQFN-EP*	0.90	0x42 (1.15V)	0x08	0x29 (0.90V)	0x00	0x38
MAX20010DATPT/V+	20 TQFN-EP*	0.75	0x42 (1.15V)	0x08	0x1A (0.75V)	0x03	0x38
MAX20010DATPY/V+	20 TQFN-EP*	1.10	0x42 (1.15V)	0X08	0X3D (1.10V)	0X03	0X38
MAX20010EATPA/V+	20 TQFN-EP*	1.20	0x4C (1.25V)	0x08	0x47 (1.20V)	0x03	0x38
MAX20010EATPB/V+**	20 TQFN-EP*	0.50	0x10 (0.65V)	0x08	0x01 (0.50V)	0x09	0x38

N denotes an automotive-qualified part.

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

^{*}EP = Exposed pad.

^{**}Future product—contact factory for availability.

Automotive Single 6A Step-Down Converters

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/17	Initial release	_
1	3/18	Updated Table 7, Output Capacitor section, and Ordering Information	16, 18–19
2	4/18	Updated Package Information table and Table 7. Added MAX20010DATPR/V+ as a future product to the Ordering Information table.	2, 16, 19
3	8/18	Updated equation in the Setting the Output Voltage Externally section. Added MAX-20010CATPE/V+** as a future product and removed future product designation from MAX20010DATPR/V+ in the Ordering Information table.	19
4	11/18	Updated Package Information table. Added MAX20010DATPT/V+ and MAX20010DAT -PO/VY+ to the Ordering Information table. Added MAX20010CATPU/V+ as a future product to the Ordering Information table.	2, 19
5	3/19	Removed future-product notation from MAX20010CATPE/V+ and MAX20010CATPU/V+ in the Ordering Information table	19
6	2/20	Added MAX20010E product variant to the following sections: General Description, Typical Application Circuit, Pin Configuration, Detailed Description, Figure 1: Internal Block Diagram, Table3: Identification Registers (ID) - Dev[7.4], Output Capacitor. Updated and added equations to: Setting the Output Voltage Externally section. Added MAX20010E-ATPA/V+ to the Ordering Information table. Updated ordering table to use 7-bit addresses.	1, 7, 8, 14, 18, 19
7	9/21	Added "Enable (EN)" subsection. Updated "Shutdown" subsection. Updated Table 2. Added MAX20010CATPB/V+, MAX20010CATPT/V+, and MAX20010CATPY/V+ as future products to the Ordering Information table. Added MAX20010CATPF/V+, MAX20010DATPQ/V+, MAX20010CATPW/V+, MAX20010CATPX/V+, and MAX20010DATPY/V+ to the Ordering Information table.	14, 16, 22
8	10/21	Added future product notation to MAX20010CATPW/V+ and MAX20010CATPX/V+	22
9	11/21	Removed future product notation from MAX20010CATPW/V+, MAX20010CATPX/V+, and MAX20010CATPY/V+	22
10	1/22	Updated Package Information table	2
11	7/22	Added MAX20010EATPB/V+ as a future product to the Ordering Information table.	22

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        MAX20010CATPM/V+
        MAX20010CATPE/V+
        MAX20010DATPR/V+
        MAX20010DATPO/V+T
        MAX20010CATPJ/V+T

        MAX20010DATPO/VY+T
        MAX20010DATPP/V+
        MAX20010CATPD/V+T
        MAX20010DATPT/V+T

        MAX20010CATPQ/V+T
        MAX20010CATPL/V+
        MAX20010DATPO/V+
        MAX20010DATPO/V+
        MAX20010DATPO/V+

        MAX20010DATPN/V+T
        MAX20010CATPD/V+
        MAX20010DATPP/V+T
        MAX20010DATPN/V+

        MAX20010CATPM/V+T
        MAX20010CATPD/V+
        MAX20010CATPD/V+
        MAX20010DATPR/V+T

        MAX20010CATPL/V+T
        MAX20010CATPD/V+
        MAX20010DATPD/V+
        MAX20010DATPD/V+

        MAX20010DATPY/V+T
        MAX20010CATPB/V+
        MAX20010CATPF/V+
        MAX20010CATPF/V+
        MAX20010CATPP/V+T

        MAX20010CATPX/V+
        MAX20010CATPY/V+
        MAX20010CATPW/V+T
        MAX20010CATPW/V+T

        MAX20010CATPX/V+T
        MAX20010CATPY/V+
        MAX20010CATPW/V+T
        MAX20010CATPW/V+T
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